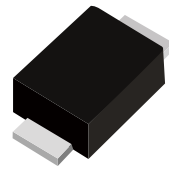
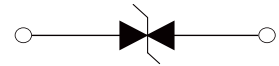


FEATURES

- | Low profile package
- | Ideal for automated placement
- | 600 Watt peak pulse power capability with a 10/1000 μ s waveform
- | For surface mounted applicatons to optimize board space
- | Excellent clamping capability
- | Very fast response time
- | Low incremental surge resistance
- | Meet AEC-Q101 Requirements



SMBF



Schematic Symbol

APPLICATIONS

- | Power supply protection
- | Automotive application
- | Industrial application
- | Power management

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation on 10/1000 μ s waveform (Note1, Note2).	P_{PPM}	600	Watts
Steady State Power Dissipation at $T_A=50^{\circ}\text{C}$ (Note2).	P_D	5.0	Watts

- Notes :** 1.Non-repetitive current pulse, $T_A=25^{\circ}\text{C}$.
 2.Mounted on 5.0mm*5.0mm (0.03mm thick) Copper Pads to each terminal.

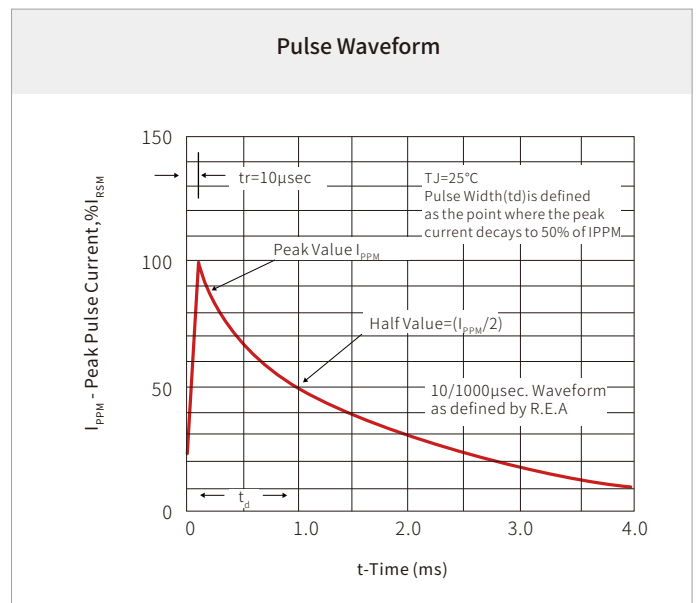
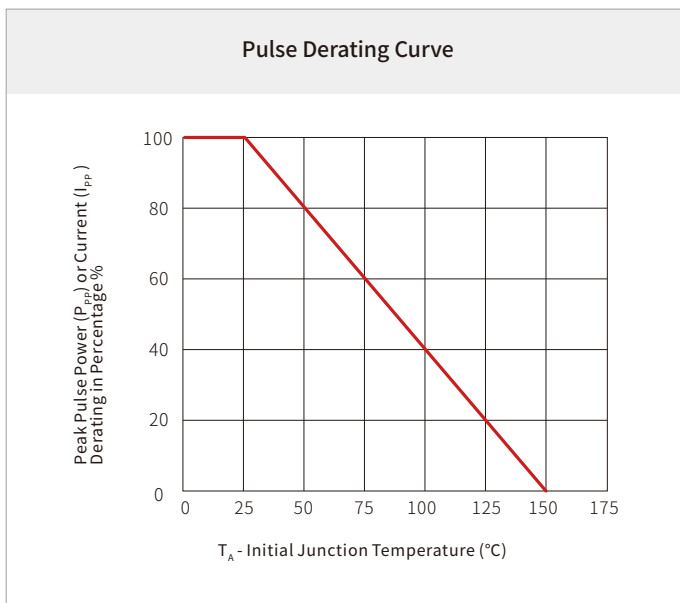
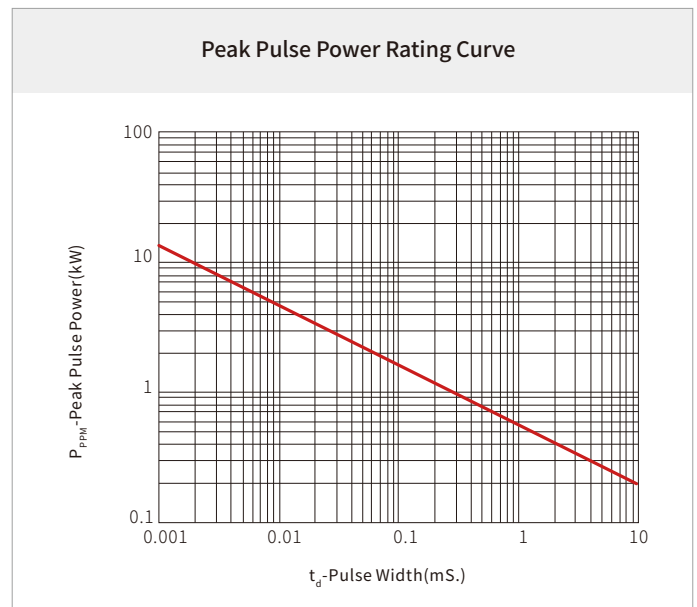
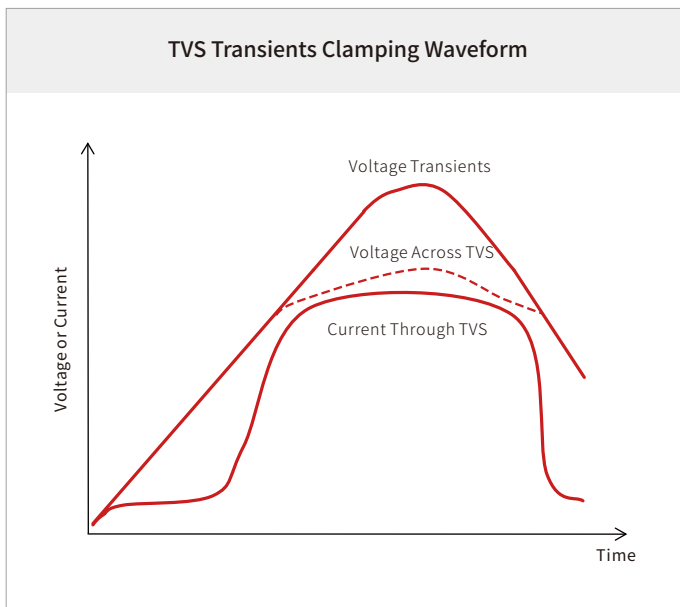
THERMAL CONSIDERATIONS

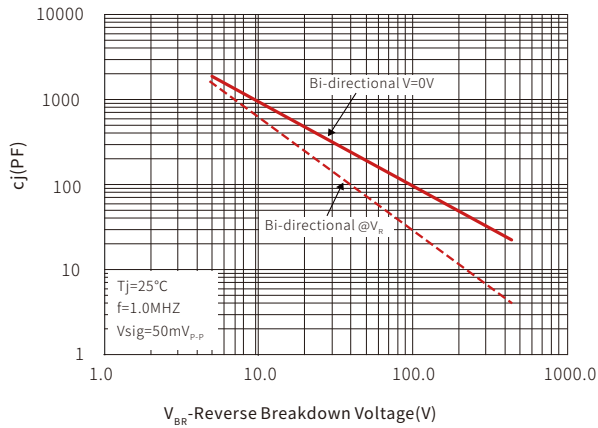
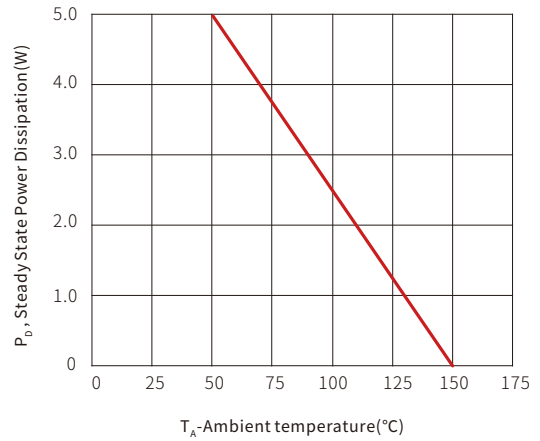
Parameter	Symbol	Value	Unit
Operating Junction Temperature	T_J	-55 to +150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^{\circ}\text{C}$
Junction to Ambient on printed circuit	$R_{\theta JA}$	90	$^{\circ}\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS (T_A=25°C)

Part Number	Device Marking Code	Reverse Stand-off Voltage	Breakdown Voltage Min.@I _T	Breakdown Voltage Max.@I _T	Test Current	Maximum Clamping Voltage @I _{PP}	Peak Pulse Current	Reverse Leakage @V _{RWM}
		V _{RWM} (V)	V _{BR} (V)	V _{BR} (V)	I _T (mA)	V _C (V)	I _{PP} (A)	I _R (uA)
TPSVBF60B18	BTA	18.0	20.0	22.1	1.0	29.2	20.6	1.0

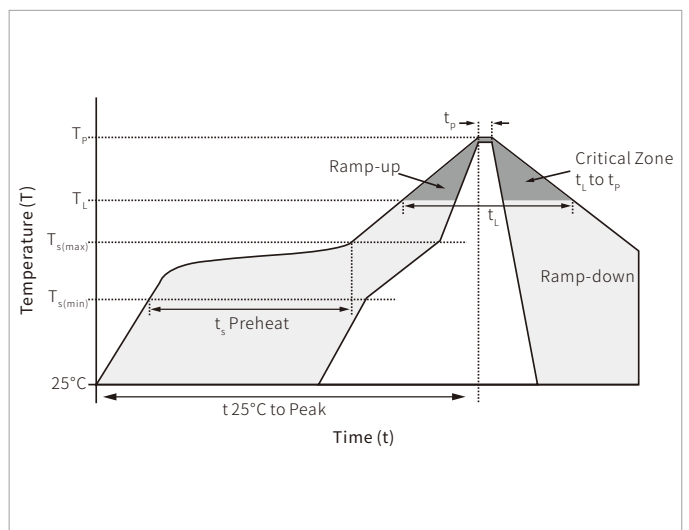
CHARACTERISTIC CURVES



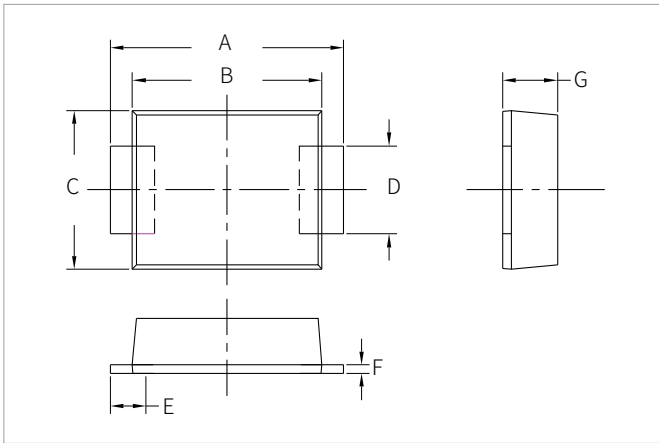
Typical Junction Capacitance

Steady State Power Dissipation Derating Curve


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_r)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

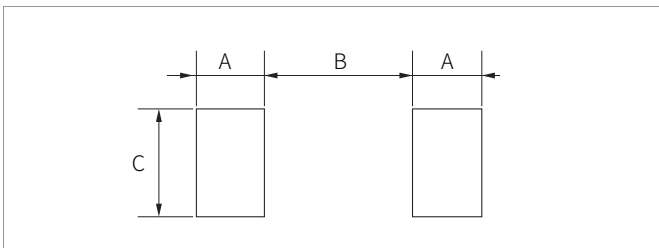


SMBF PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	5.10	5.50	0.201	0.217
B	4.10	4.50	0.161	0.177
C	3.40	3.80	0.134	0.150
D	1.90	2.10	0.075	0.083
E	0.70	-	0.028	-
F	0.15	0.25	0.006	0.010
G	1.20	2.20	0.047	0.087

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.0	-	0.079	-
B	-	2.5	-	0.098
C	2.2	-	0.087	-

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
TPSVBF60B18	SMBF	3000PCS	13"

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By QR Code

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Wechat

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